

DATASHEET

SMD • Side View LEDs 99-218UM2C/3438S96/TR8-T



Features

- . Side view white LED.
- . White SMT package.
- . Lead frame package with individual 2 pins.
- . Wide viewing angle
- . Soldering methods: IR reflow soldering
- . Pb-free
- . The product itself will remain within RoHS compliant version.
- . Compliance with EU REACH.
- . Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

Description

Due to the package design, 99-218 has wide viewing angle, low power consumption and white LEDs are devices which are materialized by combing blue chips and special phosphor. This feature makes the LED ideal for light guide application.

Applications

- Mobile phones.
- Indicators.
- Illuminations.
- Switch Lights.

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Device Selection Guide

Chip	Emitted Color	Resin Color
Materials	Limited Goldi	TOOM GOID!
InGaN	Pure White	Water Clear

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V_{R}	5	V
Forward Current	I _F	30	mA
Peak Forward Current (Duty 1/10 @10ms)	lfp	60	mA
Power Dissipation	Pd	110	mW
Operating Temperature	T_{opr}	-40 ~ +85	°C
Storage Temperature	T_{stg}	-40 ~ +90	°C
Soldering Temperature	T_{sol}	Reflow Soldering : 260 °C Hand Soldering : 350 °C	

Notes: *1The products are sensitive to static electricity and must be carefully taken when handling products.

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	lv	2000		2300	mcd	$I_F=20mA$
Luminous Flux	lv	5.60		6.44	Lm	$I_F=20mA$
Viewing Angle	201/2		120		deg	I _F =20mA
Forward Voltage	V_{F}	2.95		3.45	V	I _F =20mA
Reverse Current	I_R			50	μΑ	$V_R = 5V$

Notes:

1. Tolerance of Luminous Intensity: ±5%.

2. Tolerance of Forward Voltage: ±0.05V.

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Bin Range of Luminous Intensity

Bin Code	mcd(Min.)	mcd(Max.)	Unit	Condition	lm(Min.)	lm(Max.)	Unit	
38	2000	2050	mcd		5.60	5.74		
39	2050	2100		 mcd		5.74	5.88	
40	2100	2150			I _F =20mA	5.88	6.02	lm
41	2150	2200			6.02	6.16		
42	2200	2300			6.16	6.44		

Notes: Tolerance of Luminous Intensity, Luminous Flux: ±5%.

The spec. for intensity is quantified in Im, mcd is for reference only.

Bin Range of Forward Voltage

Group	Bin Code	Min.	Max.	Unit	Condition
_	6-1	2.95	3.05		
	6-2	3.05	3.15		
6	7-1	3.15	3.25	V	I _F =20mA
	7-2	3.25	3.35		
	8-1	3.35	3.45		

Note: Tolerance of Forward Voltage: ±0.05V



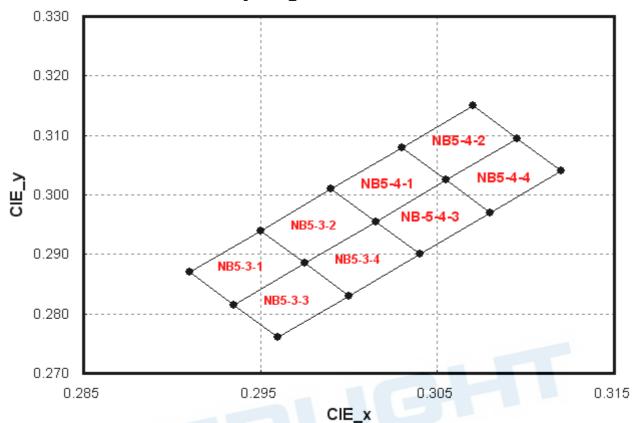
Chromaticity Coordinates of Bin Code

Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y
_	0.2935	0.2815		0.2975	0.2885
NB5-3-1	0.2910	0.2870	– NB5-3-2 –	0.2950	0.2940
-	0.2950	0.2940		0.2990	0.3010
	0.2975	0.2885		0.3015	0.2955
_	0.2960	0.2760		0.3000	0.2830
NB5-3-3 -	0.2935	0.2815	– NB5-3-4 –	0.2975	0.2885
-	0.2975	0.2885		0.3015	0.2955
	0.3000	0.2830		0.3040	0.2900
_	0.3015	0.2955		0.3055	0.3025
NB5-4-1 -	0.2990	0.3010	– NB5-4-2 –	0.3030	0.3080
-	0.3030	0.3080		0.3070	0.3150
	0.3055	0.3025		0.3095	0.3095
_	0.3040	0.2900		0.3080	0.2970
NB5-4-3 -	0.3015	0.2955	– NB5-4-4 –	0.3055	0.3025
	0.3055	0.3025		0.3095	0.3095
	0.3080	0.2970		0.3120	0.3040

Notes: Tolerance of Chromaticity Coordinates: ±0.01

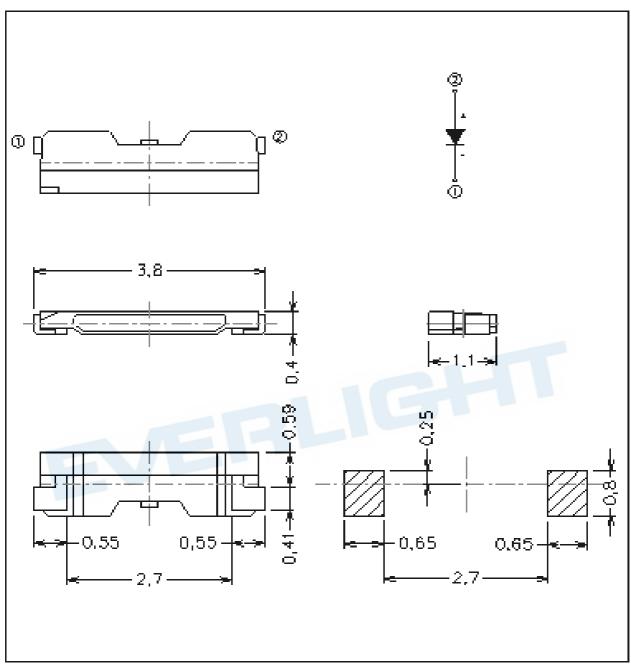


The C.I.E. 1931 Chromaticity Diagram





Package Outline Dimensions

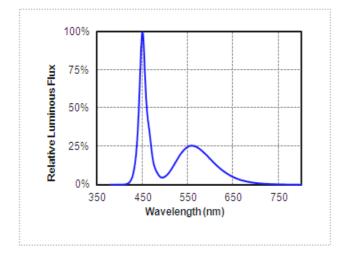


Notes: The tolerances unless mentioned is ± 0.1 mm, Unit = mm.

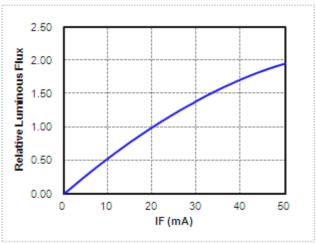


Typical Electro-Optical Characteristics Curves

1. Spectrum Distribution (Ta=25°C, I_F=20mA)

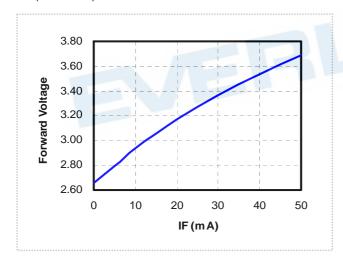


2. Relative Luminous Flux vs. Forward Current $(T_a=25^{\circ}C)$



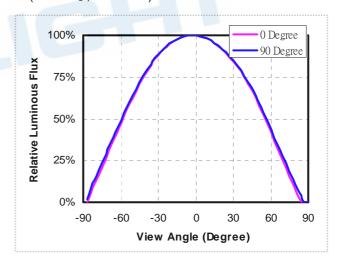
3. Relative Forward Voltage vs. Forward Current

(TA=25°C)



4. Radiation Diagram

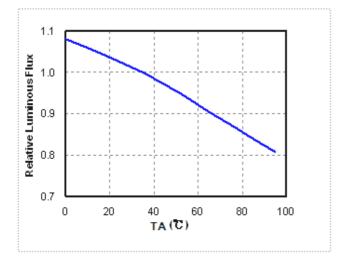
(TA=25°C, IF=20mA)

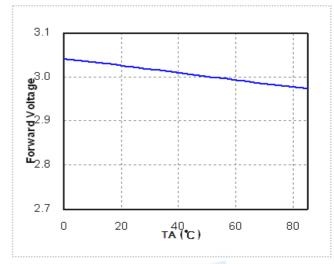




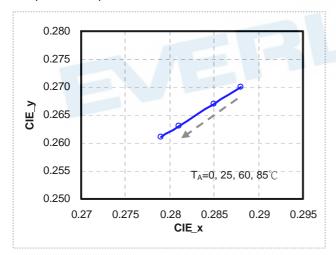
Typical Electro-Optical-Thermal Characteristics Curves

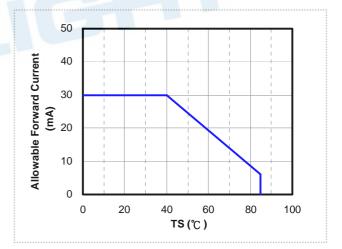
5. Relative Luminous Flux vs. Ambient Temperature 6. Forward Voltage vs. Ambient Temperature (I_F=20mA) (I_F=20mA)





7. Chromaticity Coordinates vs. Ambient Temperature 8. Forward Current De-rating Curve (IF=20mA)







Label Explanation

· CAT: Luminous Flux Rank

· HUE: Chromaticity Coordinates

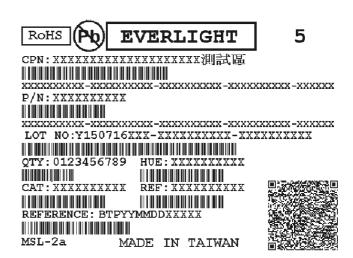
· CPN: Customer's Product Number

· P/N: Product Number

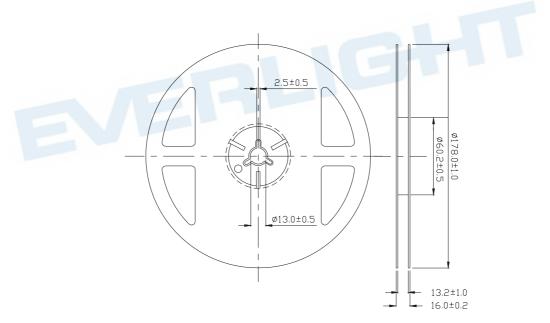
QTY: Packing Quantity

· REF: Forward Voltage Rank

· LOT No: Lot Number



Reel Dimensions



Note:

The tolerances unless mentioned is ± 0.1 mm,Unit = mm.

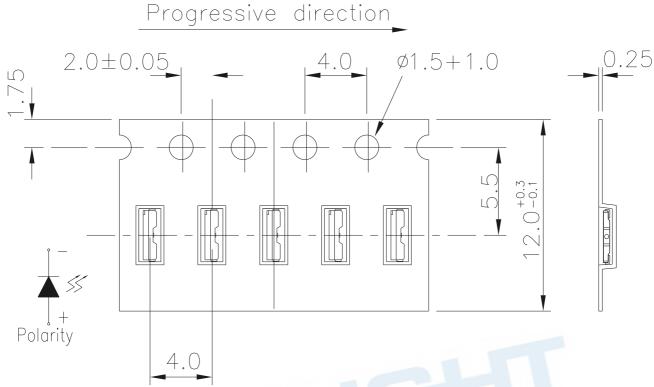
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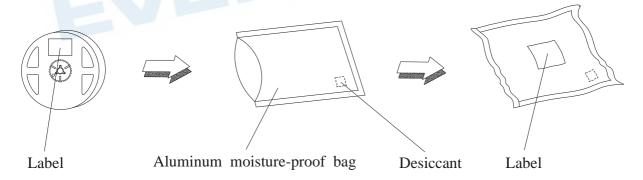


Carrier Tape Dimensions: Loaded Quantity 1000/2000 pcs. Per Reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm.

Moisture Resistant Packaging





Reliability Test Items and Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

		Test Condition	Test	Criteria		
NO	Item	Temp./ Humidity	I _F (mA)	Hours / Times	Iv @ 20mA	V _F @ 20mA
1	Reflow Soldering	TSld = 260°ℂ, Max.	10sec.	2 times	<±5%	<±5%
2	Temperature Cycle	_	00℃ 30min.	200 cycles		
3	Thermal Shock	-10°C ~ 1 20min. (<15sec.)	00℃ 20min.	200 cycles		
4	Low Temp. Storage	Ta= -40°C		1000 hrs		
5	High Temp. Storage	Ta= 100°C		1000 hrs		
6	Temp. Humidity Storage	Ta= 60°C / 90%RH		1000 hrs	lv > '	70%,
7	Steady State Operating Life of Low Temp.	Ta= -40°C	20	1000 hrs		110%,
8	Steady State Operating Life Condition 1	Ta= 25°C/ Room Humidity	20	1000 hrs		
9	Steady State Operating Life Condition 2	Ta= 60°C	20	1000 hrs		
10	Steady State Operating Life of High Temp.	Ta= 85°℃	5	1000 hrs		
11	Steady State Operating Life of High Humidity Heat	Ta= 60°C/ 90%RH	20	1000 hrs		

Notes:

- 1. Sampling for each test item: 22 (pcs.)
- 2. Test board: MCPCB board thickness=1.0mm, copper layer thickness=0.07mm, Rth j-a = 380°C/W.
- 3. Measurements are performed after allowing the LEDs to return to room temperature.

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Precautions for Use

1. Over-current-proof

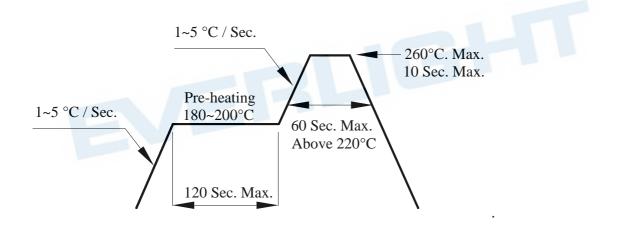
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be used within one year and kept at 30° C or less and 70%RH or less.
- 2.3 After opening the package: We recommend that the LED should be soldered quickly (within 3 days). The soldering condition is 30℃ or less and 60%RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5°C for 24 hours. (One time only)

3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

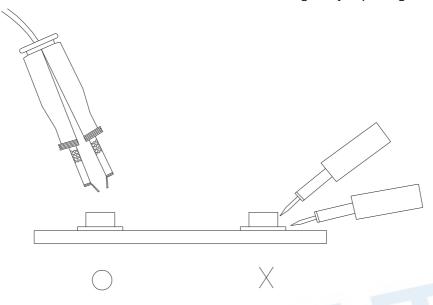
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5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



6. Handling Indications

During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound.

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